

## Supplementary information

# Dissociate Transfer Exchange of Tandem Dynamic Bonds Enables Covalent Adaptable Networks Fast Reprocessability & High Performance

Xiwei Xu,<sup>a,b</sup> Songqi Ma,<sup>a\*</sup> Hongzhi Feng,<sup>a,b</sup> Jianfan Qiu,<sup>a,b</sup> Sheng Wang,<sup>a,b</sup> Zhen Yu,<sup>a</sup> Jin Zhu<sup>a\*</sup>

<sup>a</sup> Key laboratory of bio-based polymeric materials technology and application of Zhejiang province, Laboratory of Polymers and Composites, Ningbo Institute of Materials Technology and Engineering, Chinese Academy of Sciences, Ningbo 315201, P. R. China;

<sup>b</sup> University of Chinese Academy of Sciences, Beijing 100049, P. R. China;

\*Corresponding authors: (Songqi Ma) E-mail masongqi@nimte.ac.cn, Tel 86-0574-87619806; (Jin Zhu) E-mail jzhu@nimte.ac.cn.

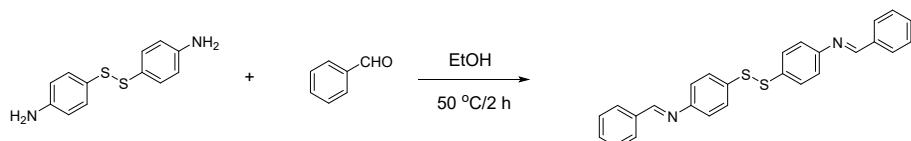
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### Synthesis of disulfanediylbis(4,1-phenylene)bis(1-phenylmethanimine) (DSBP)

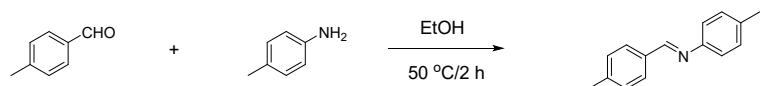
4.96 g (0.02 mol) of 4,4'-dithiodianiline and 4.24 g (0.04 mol) of benzaldehyde were dissolved in 200 mL of EtOH, and poured into a 500-mL flask equipped with a magnetic stirrer. The mixture reacted at 50 °C for 2 h, and a large amount of light-yellow powder disulfanediylbis(4,1-phenylene)bis(1-phenylmethanimine) (DSBP, 6.98 g, yield: 82.2%) was obtained by suction and being dried in a vacuum oven at 80 °C for 4 h.



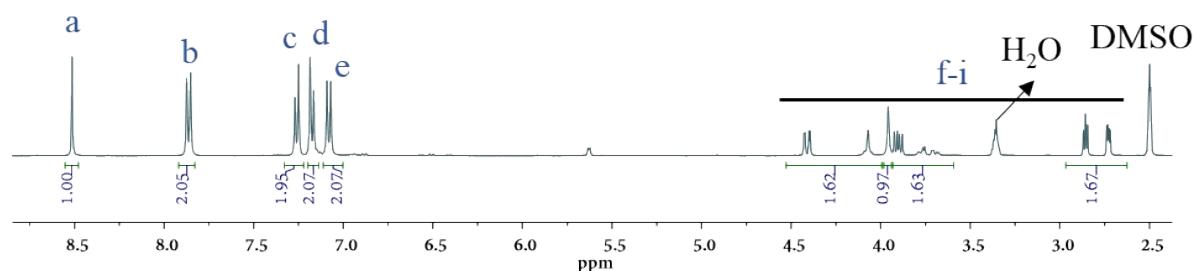
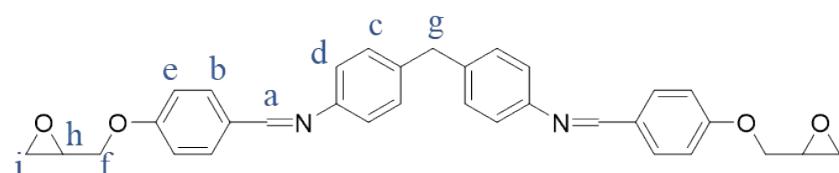
**Scheme S1** Synthetic route of DSBP.

### Synthesis of di-p-tolylmethanimine (DTMI)

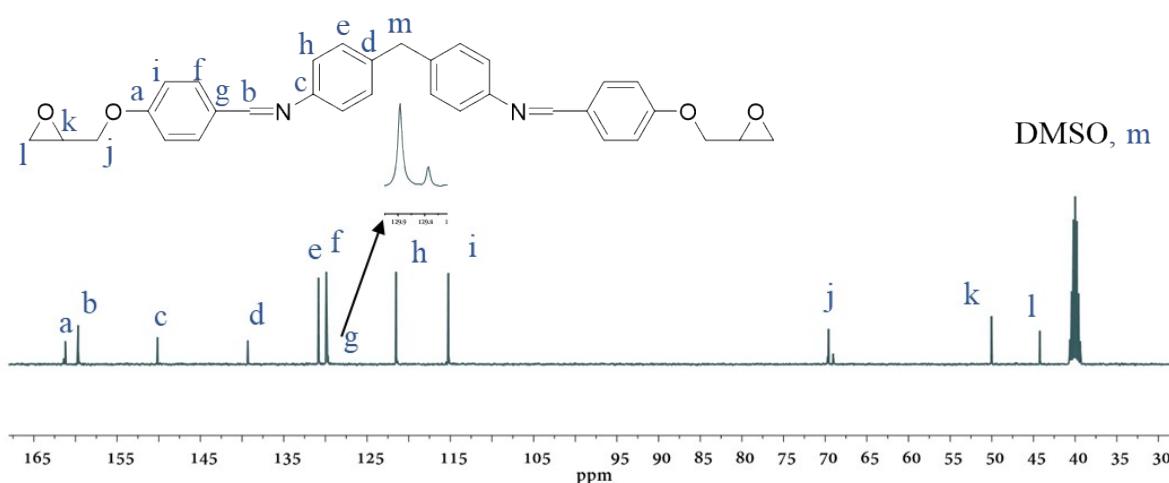
2.40 g (0.02 mol) of *p*-tolualdehyde and 2.14 g (0.02 mol) of *p*-toluidine were dissolved in 100 mL EtOH, and poured into a 250-mL flask equipped with a magnetic stirrer. The mixture reacted at 50 °C for 2 h, and yellow solution was obtained. Then rotary steaming the solution to about 20 mL at R.T., a large amount of transparent crystal di-*p*-tolylmethanimine (DTMI, 3.28 g, yield: 78.5%) was obtained by suction and being dried in a vacuum oven at 80 °C for 4 h.



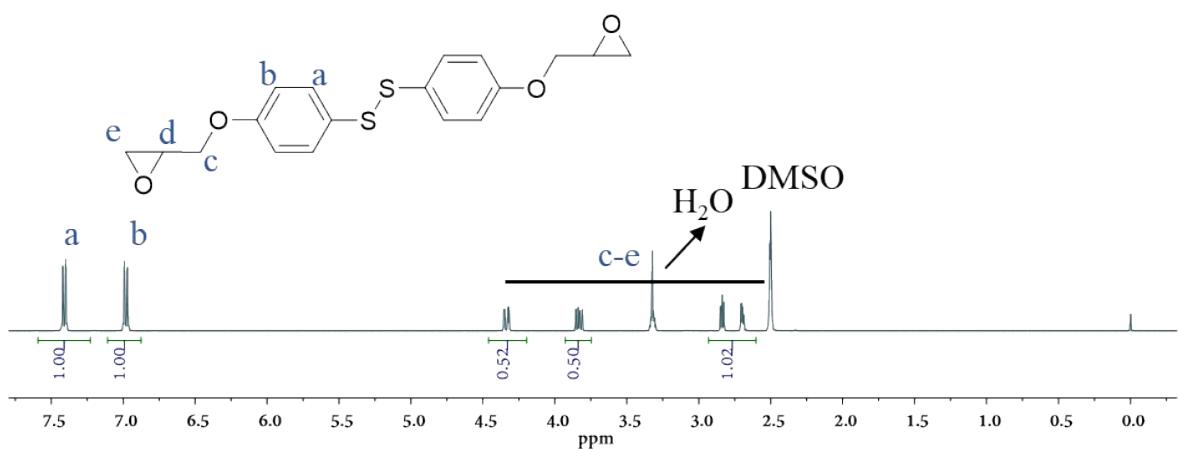
**Scheme S2** Synthetic route of DTMI.



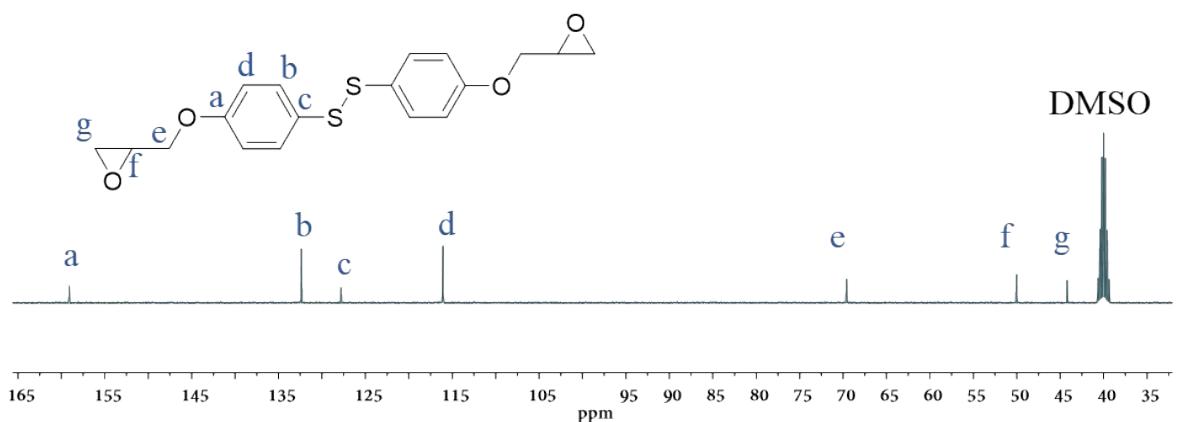
**Fig. S1** <sup>1</sup>H NMR spectrum of DDMEP.



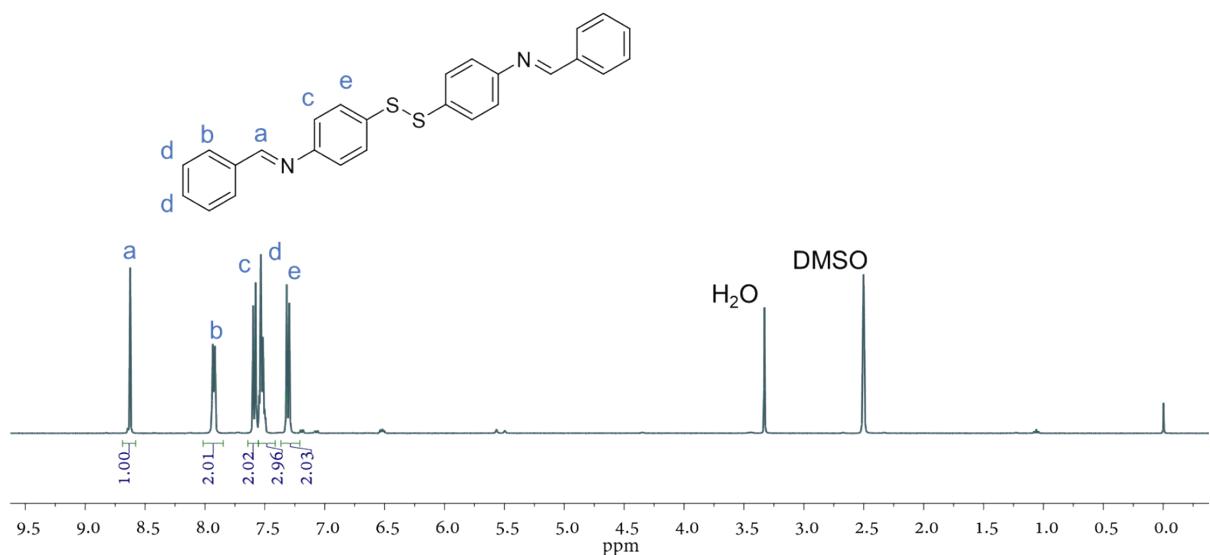
**Fig. S2** <sup>13</sup>C NMR spectrum of DDMEP.



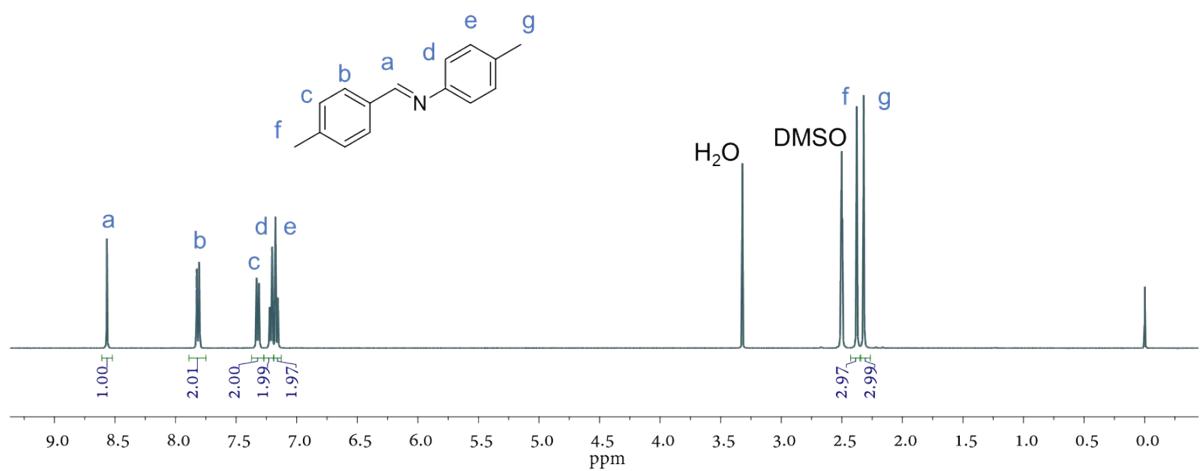
**Fig. S3**  $^1\text{H}$  NMR spectrum of SEP.



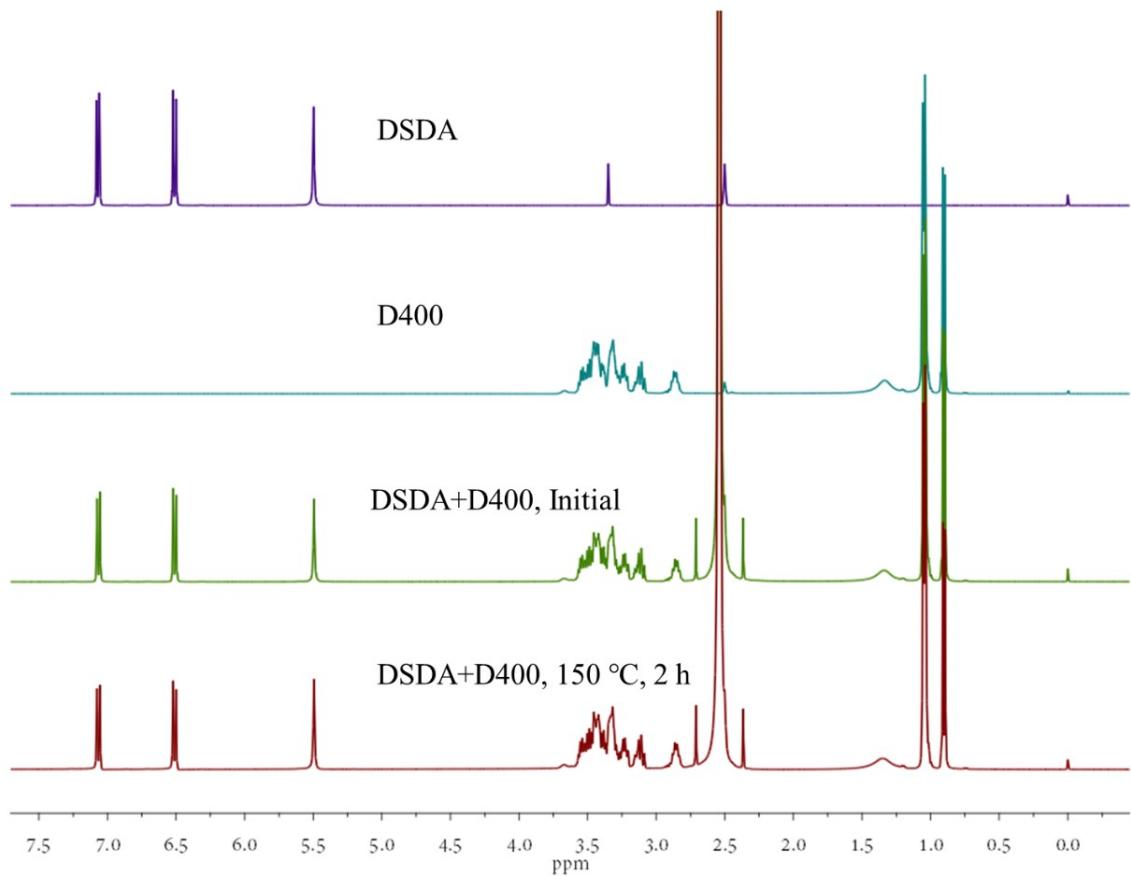
**Fig. S4**  $^{13}\text{C}$  NMR spectrum of SEP.



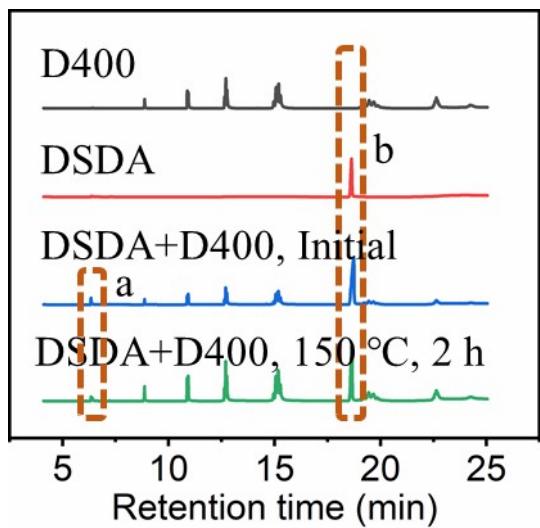
**Fig. S5**  $^1\text{H}$  NMR spectrum of DSBP.



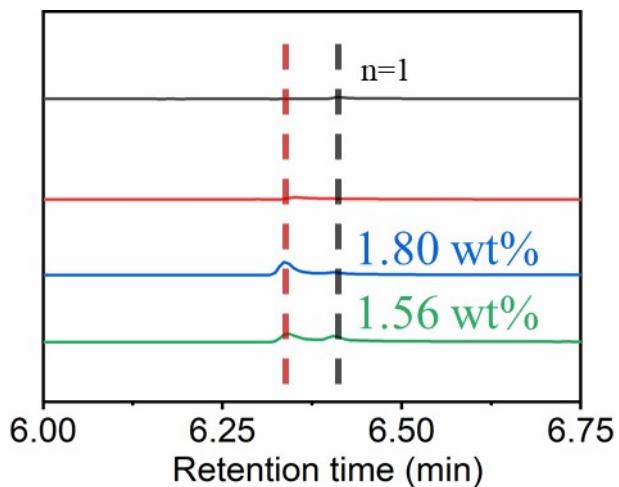
**Fig. S6** <sup>1</sup>H NMR spectrum of DTMI.



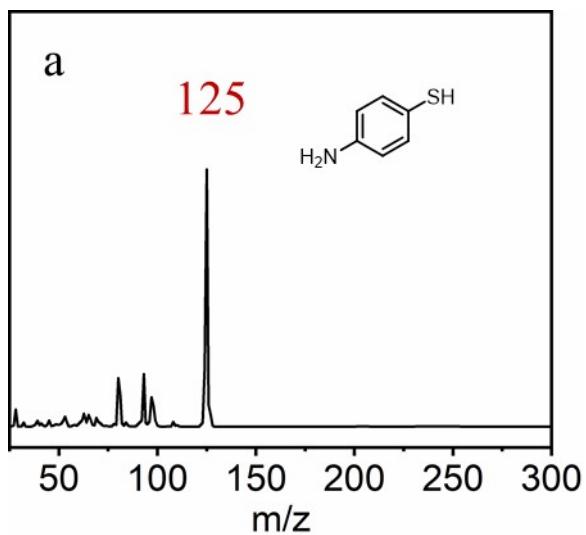
**Fig. S7** <sup>1</sup>H NMR spectra of DSDA, D400 and their mixture before and after heating at 150 °C for 2 h.



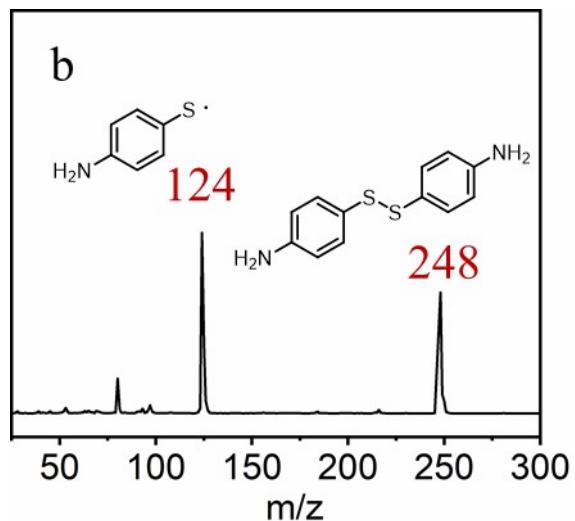
**Fig. S8** GC spectra of D400, DSDA and their mixture before and after heating at 150 °C for 2 h.



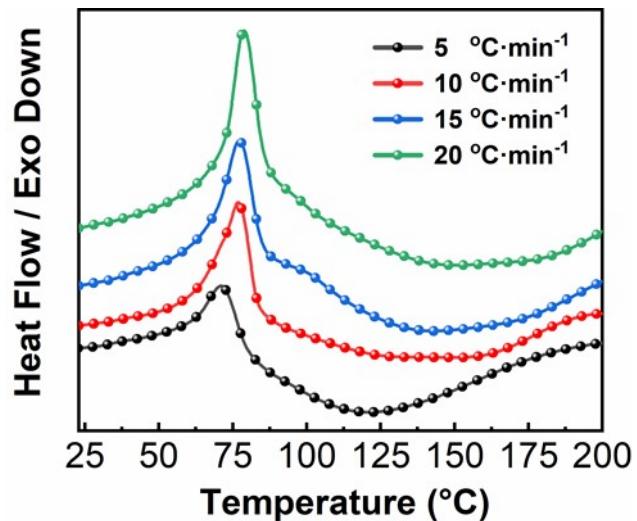
**Fig. S9** Enlarged spectra of Fig. S8 at the retention time between 6-6.75 min.



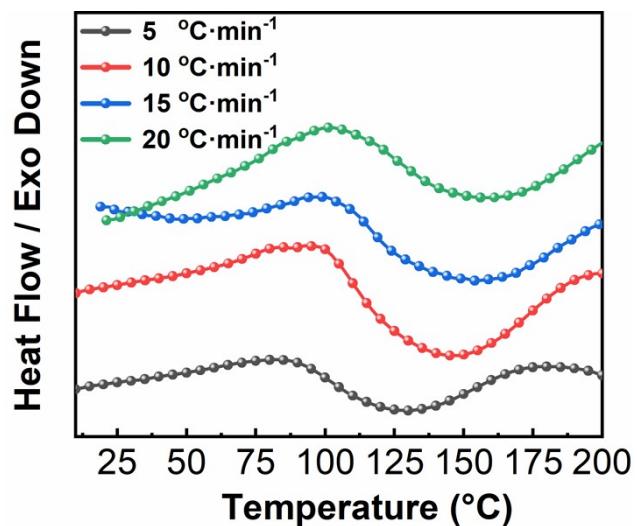
**Fig. S10** MS spectrum of compound a in Fig. S8.



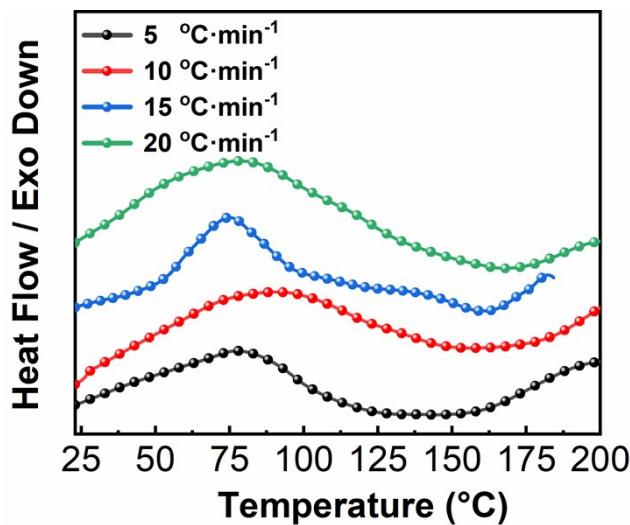
**Fig. S11** MS spectrum of compound b in Fig. S8.



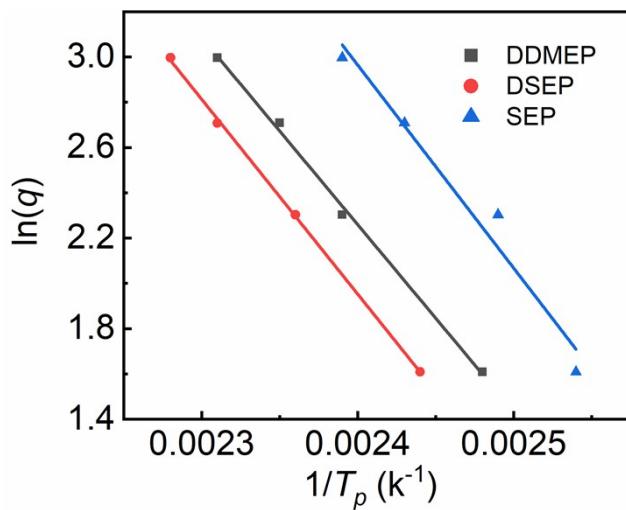
**Fig. S12** DSC curves of the SEP-D400 system at different heating rates.



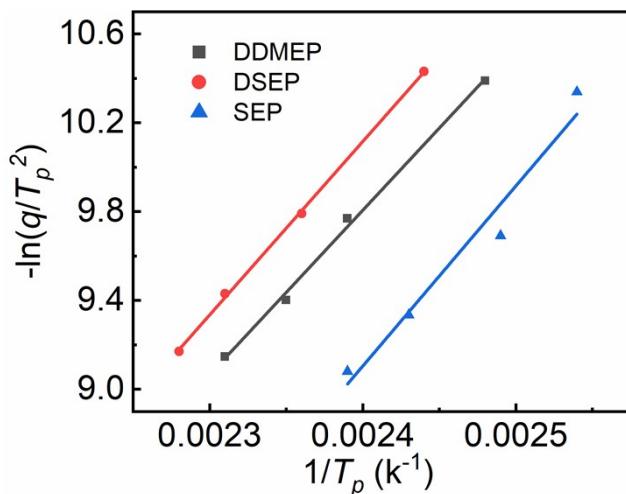
**Fig. S13** DSC curves of the DDMEP-D400 system at different heating rates.



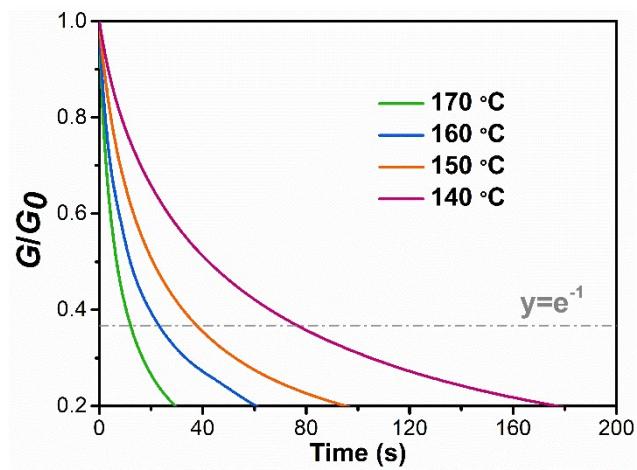
**Fig. S14** DSC curves of the DSEP-D400 system at different heating rates.



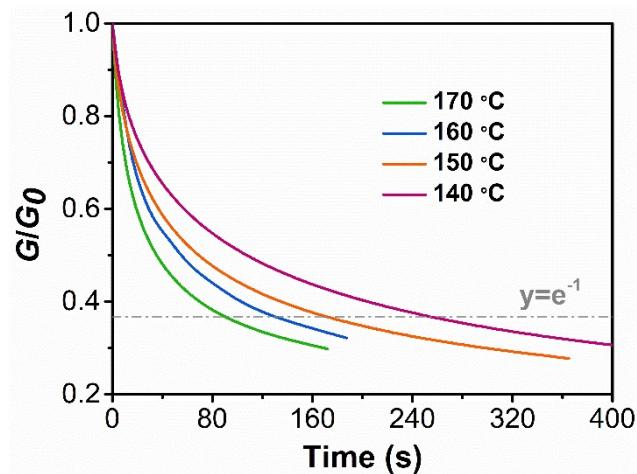
**Fig. S15** Linear plots of  $-\ln(q)$  versus  $1/T_p$  based on Ozawa's theory.



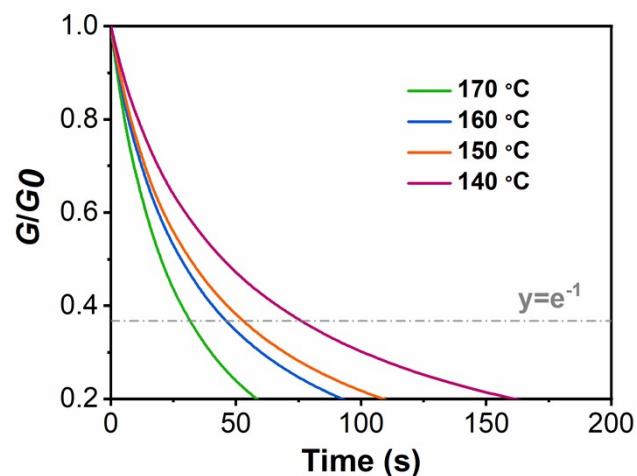
**Fig. S16** Linear plots of  $-\ln(q/T_p^2)$  versus  $1/T_p$  based on Kissinger's equation.



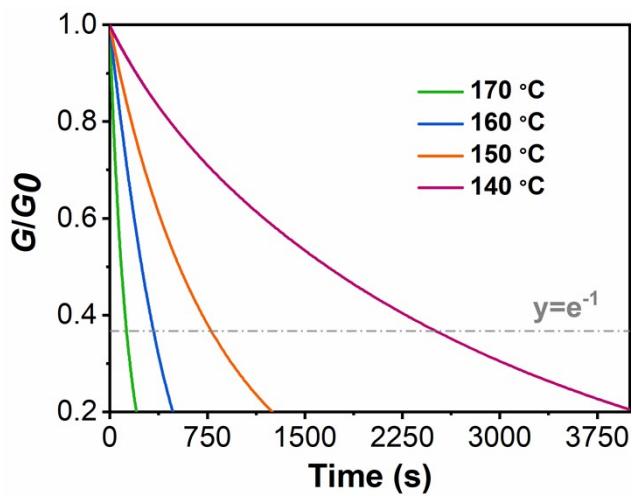
**Fig. S17** Stress relaxation curves of DSEP-D400 at different temperatures.



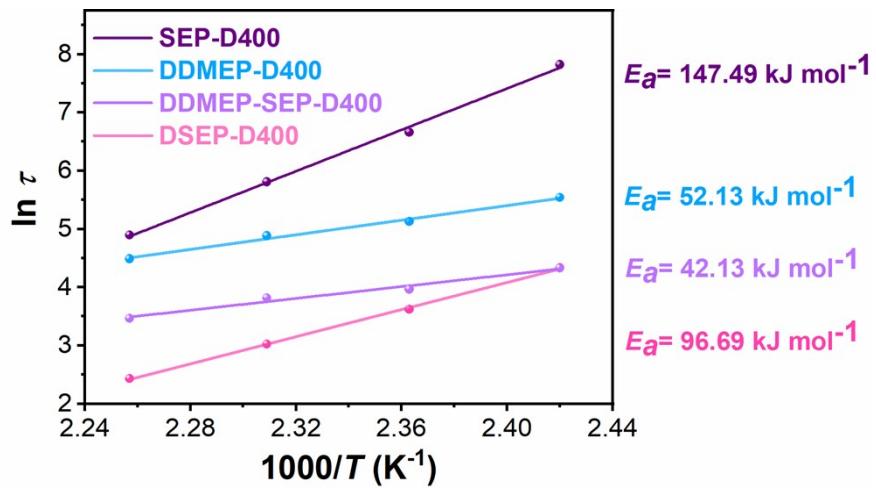
**Fig. S18** Stress relaxation curves of DDMEP-D400 at different temperatures.



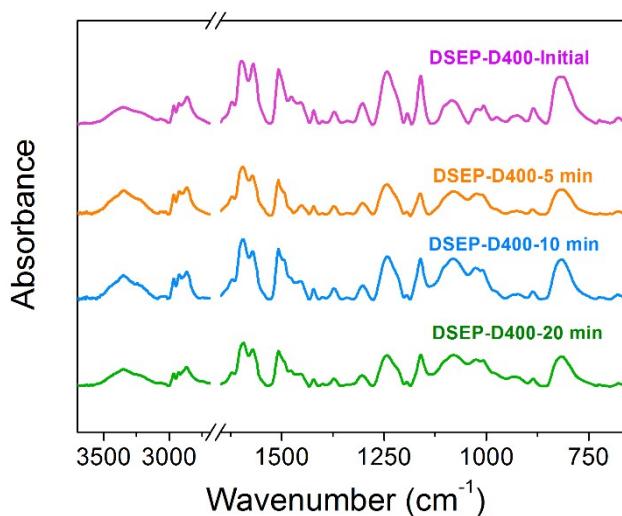
**Fig. S19** Stress relaxation curves of DDMEP-SEP-D400 at different temperatures.



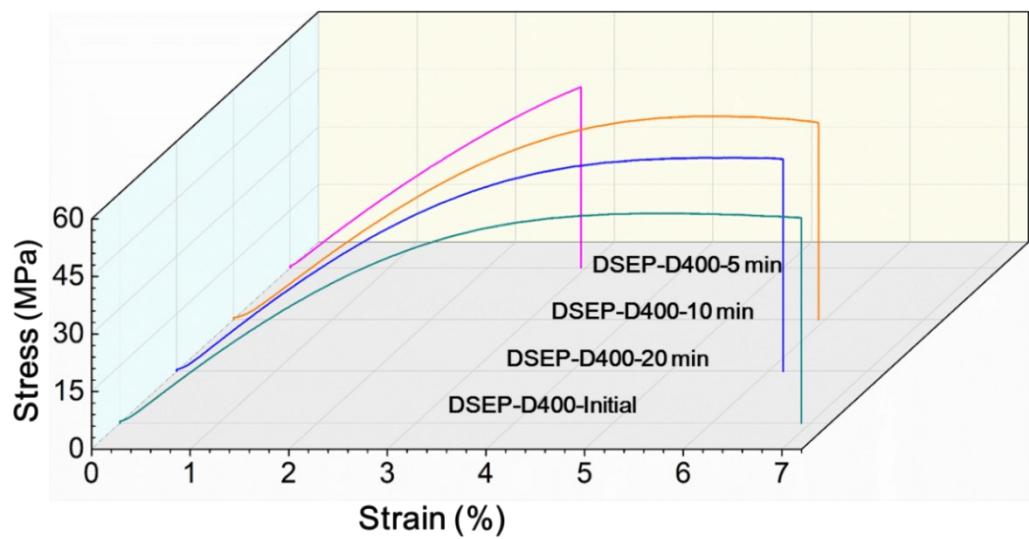
**Fig. S20** Stress relaxation curves of SEP-D400 at different temperatures.



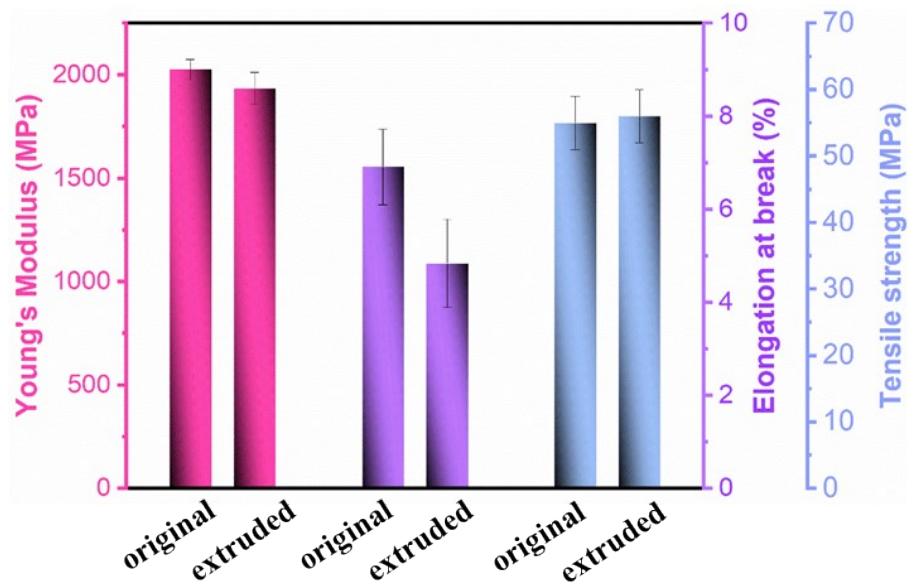
**Fig. S21** The fitted curves between  $\ln (\tau^*)$  and  $1000/T$ , and the calculated  $E_a$ s of the CANs.



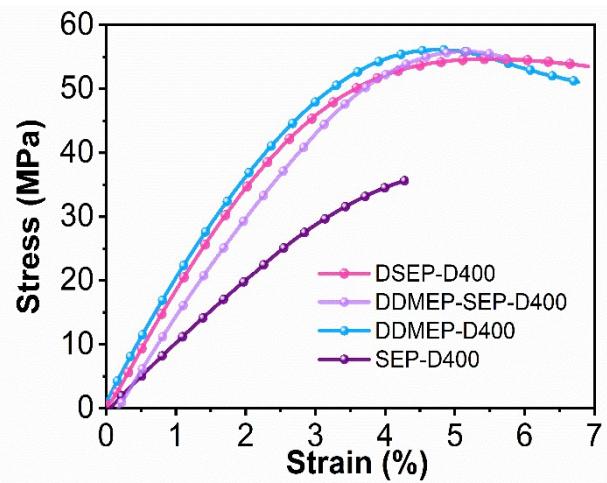
**Fig. S22** FTIR spectra of DSEP-D400 after reprocessing by hot press at 160 °C, 10 MPa for different times.



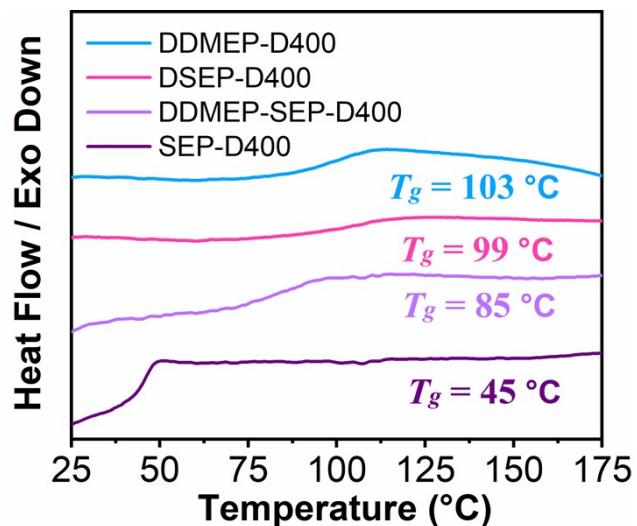
**Fig. S23** Representative tensile stress-strain curves of DSEP-D400 after reprocessing by hot press at 160 °C, 10 MPa for different times.



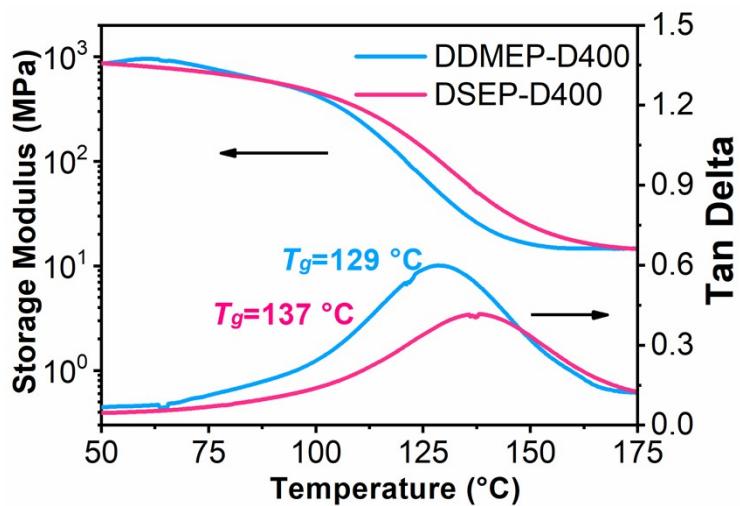
**Fig. S24** Young's modulus, elongation at break and tensile strength of the original and extruded DSEP-D400.



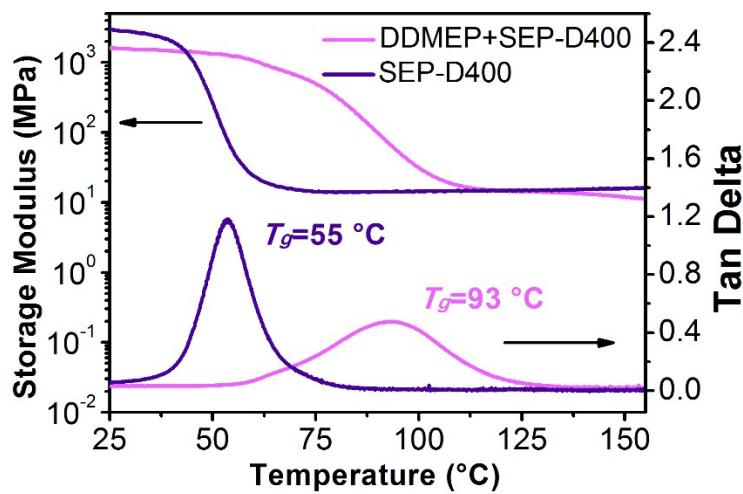
**Fig. S25** Representative tensile stress-strain curves of DSEP-D400, DDMEP-SEP-D400, DDMEP-D400 and SEP-D400.



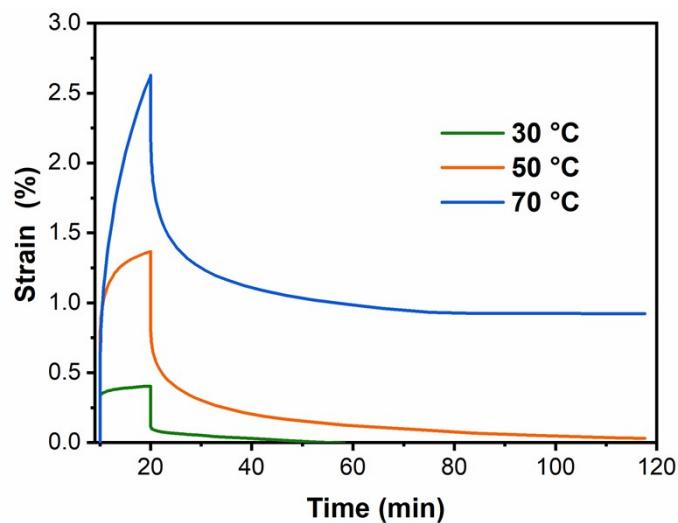
**Fig. S26** DSC curves of DSEP-D400, DDMEP-SEP-D400, DDMEP-D400 and SEP-D400.



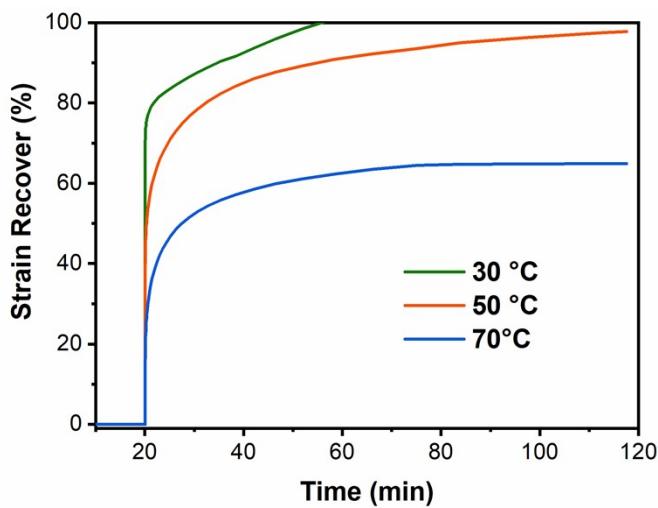
**Fig. S27** DMA curves of DDMEP-D400 and DSEP-D400.



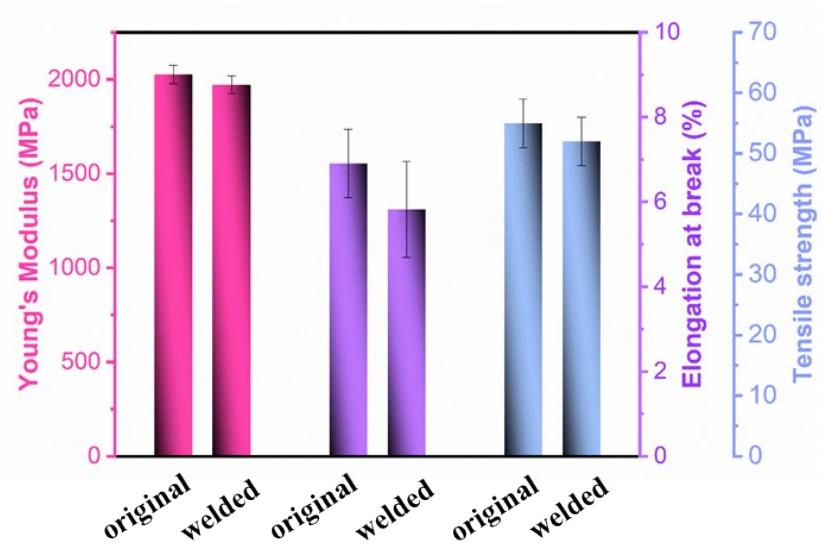
**Fig. S28** DMA curves of DDMEP-SEP-D400 and SEP-D400.



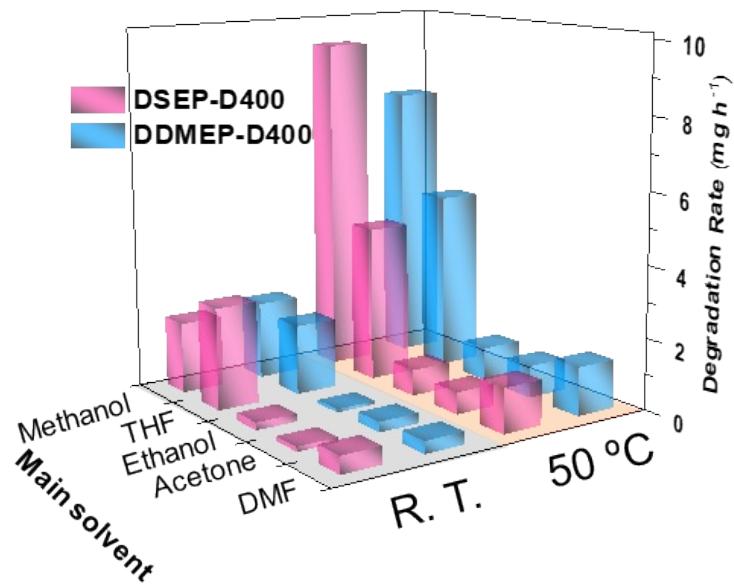
**Fig. S29** Creep curves of DSEP -D400.



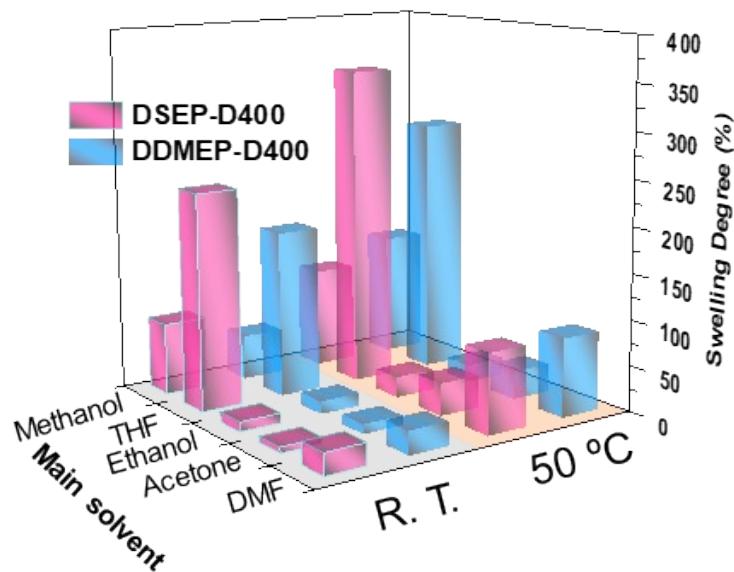
**Fig. S30** Strain recovery of DSEP -D400.



**Fig. S31** Young's modulus, elongation at break and tensile strength of the original and welded DSEP-D400.



**Fig. S32** Degradation rate of DDMEP-D400 and DSEP-D400 in 1 M HCl water/main solvent (2/8, v/v) solution with different main solvent at room temperature and 50 °C.



**Fig. S33** Swelling degree of DDMEP-D400 and DSEP-D400 in water/main solvent (2/8, v/v) solution with different main solvent at room temperature and 50 °C.

**Table S1** Formulations of different samples.

Sample	DSEP (g)	DDMEP (g)	SEP (g)	D400 (g)
DSEP-D400	5.69	/	/	2.00
DDMEP-D400	/	5.19	/	2.00
DDMEP-SEP-D400	/	2.59	1.81	2.00
SEP-D400	/	/	3.62	2.00

**Table S2** Peak temperatures of the non-isothermal DSC curves of different curing systems at different heating rates and their activation energies ( $E_a$ s).

Sample	$T_p$ under different heating rates (K)				$E_a$ s (kJ mol <sup>-1</sup> )	
	5 °C min <sup>-1</sup>	10 °C min <sup>-1</sup>	15 °C min <sup>-1</sup>	15 °C min <sup>-1</sup>	Kissinger	Ozawa
DSEP	409	423	433	439	64.9	67.9
DDMEP	403	418	426	433	61.5	65.2
SEP	393	402	412	419	67.4	70.8

**Table S3** Mechanical Properties of DSEP-D400 before and after recycling.

Sample	Young's modulus (MPa)	Tensile strength (MPa)	Elongation at break (%)
Original	2072±49	55±7	6.91±0.81
Hot press-5 min	1920±62	47±4	2.95±0.36
Hot press-10 min	1980±48	53±4	5.93±0.49
Hot press-20 min	2040±35	56±5	6.15±0.61
Welding	1973±46	52±4	5.82±0.37

**Table S4** Mechanical properties of different samples.

Sample	Young's modulus (MPa)	Tensile strength (MPa)	Elongation at break (%)
DSEP-D400	2072±49	55±7	6.91±0.81
DDMEP-D400	2170±73	56±4	6.77±0.72
DDMEP-SEP-D400	1869±67	56±4	5.75±0.48
SEP-D400	1140±86	36±6	4.28±0.55
DER331-D400 <sup>1</sup>	1186±14	36±3	6.1±0.3

**Table S5** Thermal properties of different samples.

Sample	$T_g$ (°C, DSC)	$T_g$ (°C, DMA)	$E'$ (MPa)	$\nu_e$ (mol cm <sup>-3</sup> )	$T_{d5\%}$ (°C)	$T_{d30\%}$ (°C)	$R_{800}$ (%)	$T_s$ (°C)
DSEP-D400	99	137	14.33	1274	273	322	27.08	148
DDMEP-D400	103	129	14.74	1315	279	354	32.69	159
DDMEP-SEP-D400	85	93	14.47	1465	303	350	25.21	162
SEP-D400	45	55	13.72	1536	290	327	11.92	153
DER331-D400 <sup>1</sup>	53	55	8.77	1068	367	388	6.39	186

$$T_s = 0.49[T_{d5\%} + 0.6(T_{d30\%} - T_{d5\%})]$$

## References

- 1 X. Xu, S. Ma, S. Wang, J. Wu, Q. Li, N. Lu, Y. Liu, J. Yang, J. Feng and J. Zhu, *J. Mater. Chem. A*, 2020, **8**, 11261-11274.